



Click [here](#) for the 3D model.

#### General Information

|             |                             |
|-------------|-----------------------------|
| Series      | CAN SMD Indust 250          |
| Style       | SMD Chip                    |
| Description | SMD Chip, MLCC, AC Rated    |
| Features    | Temperature Stable, Class I |
| RoHS        | Yes                         |
| Termination | Flexible Termination        |
| Marking     | No                          |
| AEC-Q200    | No                          |
| Shelf Life  | 78 Weeks                    |
| MSL         | 1                           |

#### Dimensions

|           |                 |
|-----------|-----------------|
| Chip Size | 2225            |
| L         | 5.9mm +/-0.75mm |
| W         | 6.4mm +/-0.4mm  |
| T         | 2.5mm +/-0.20mm |
| B         | 0.7mm +/-0.35mm |

#### Packaging Specifications

|                    |           |
|--------------------|-----------|
| Packaging          | Bulk, Bag |
| Packaging Quantity | 1         |

#### Specifications

|  |                     |
|--|---------------------|
| Capacitance  | 0.12 uF             |
| Measurement Condition  | 1 kHz 1.0Vrms       |
| Tolerance  | 5%                  |
| Voltage AC   | 250 VAC             |
| Dielectric Withstanding Voltage                                    | 945 VDC             |
| Temperature Range  | -55/+125°C          |
| Temp. Coefficient  | COG                 |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms   |
| Dissipation Factor   | 0.1% 1 kHz 1.0Vrms  |
| Aging Rate   | 0% Loss/Decade Hour |
| Insulation Resistance  | 8.333 GOhms         |

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